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### FDD7N25LZ N-Channel UniFET<sup>™</sup> MOSFET **250 V, 6.2 A, 550 m**Ω

#### **Features**

- R<sub>DS(on)</sub> = 430 mΩ (Typ.) @ V<sub>GS</sub> = 10 V, I<sub>D</sub> = 3.1 A
- Low Gate Charge (Typ. 12 nC)
- Low C<sub>rss</sub> (Typ. 8 pF)
- · 100% Avalanche Tested
- · Improved dv/dt Capability
- · ESD Improved Capability
- RoHS Compliant

#### Applications

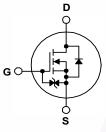
- LCD/LED/PDP TV
- · Consumer Appliances
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

FDD7N25LZ — N-Channel UniFET<sup>TM</sup> MOSFET

## Description

UniFET<sup>TM</sup> MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.





#### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

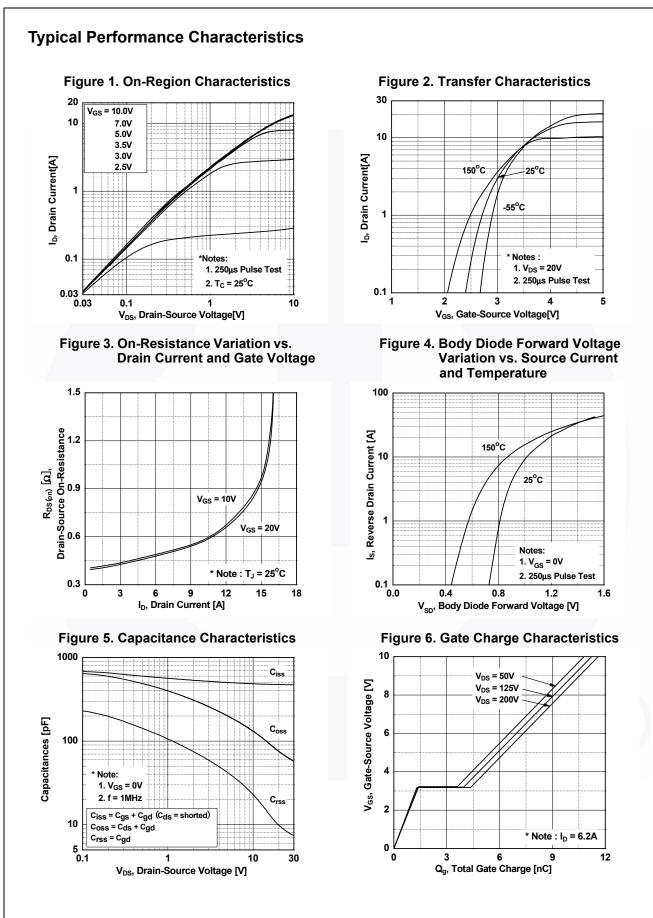
Symbol	Parameter			FDD7N25LZTM	Unit	
V <sub>DSS</sub>	Drain to Source Voltage			250	V	
V <sub>GSS</sub>	Gate to Source Voltage			±20	V	
I <sub>D</sub>	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		6.2	^	
	Drain Current	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		3.7	- A	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	25	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)			115	mJ	
I <sub>AR</sub>	Avalanche Current		(Note 1)	5.5	Α	
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	5.6	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	ote 3) 10			
P <sub>D</sub>	Deven Dississeties	(T <sub>C</sub> = 25 <sup>o</sup> C)		56	W	
	Power Dissipation	- Derate Above 25°C		0.45	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			°C	

#### **Thermal Characteristics**

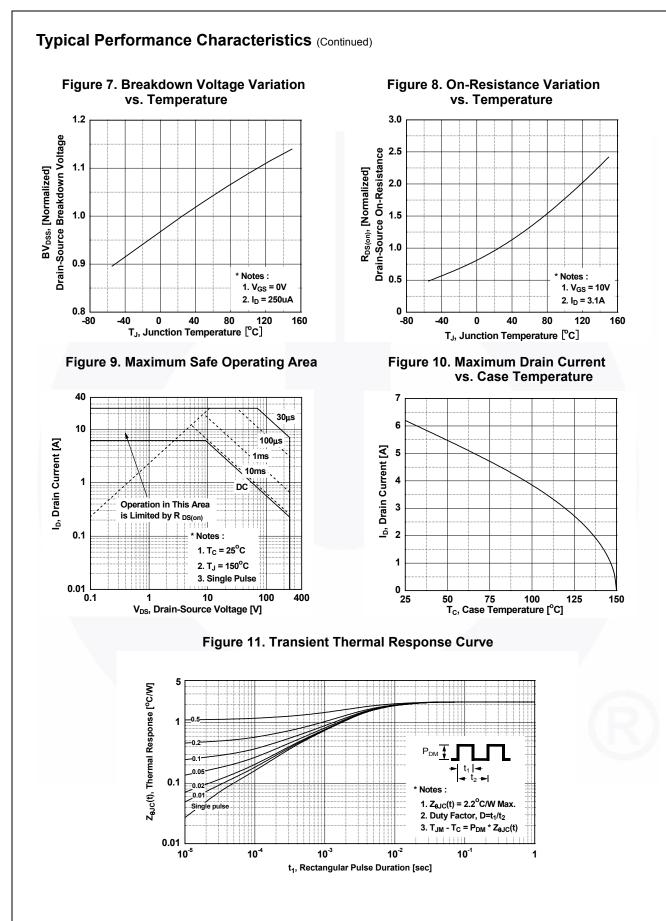
FDD7N25LZ Rev. 1.5

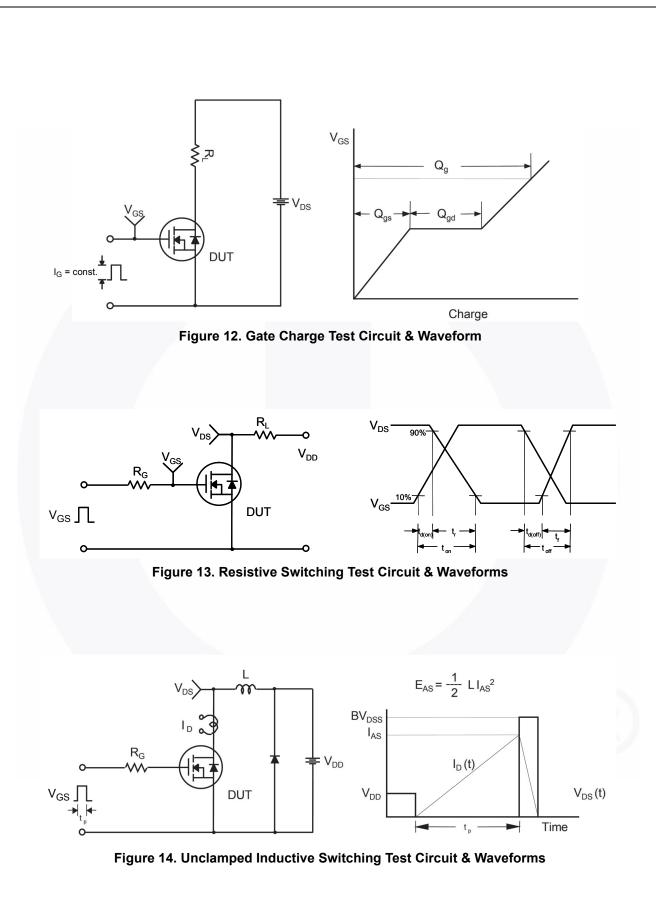
Symbol	Parameter	FDD7N25LZTM		
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	2.2	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	110	0/11	

Part Number		Top Mark	Packag	e Packing Method	Reel Size	e Ta	ape Width	Qu	antity
FDD7N25			DPAK	Tape and Reel	330 mm		16 mm	2500 units	
Electrica	l Chara	icteristics T <sub>C</sub> = 25°	C unless ot	herwise noted.					
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristics								
BV <sub>DSS</sub>				= -250 + 4 + 1/2 = -0.1/1	$= 25^{\circ}$ C	250	-		V
∆BV <sub>DSS</sub>	Drain to Source Breakdown Voltage Breakdown Voltage Temperature			$I_D = 250 \ \mu\text{A}, \ V_{GS} = 0 \ V, \ T_C = 25^{\circ}\text{C}$		200	-	-	-
$/\Delta T_J$ Coefficier				$I_D = 250 \ \mu$ A, Referenced to $25^{\circ}$ C		-	0.25	-	V/°C
	Zoro Cot			V <sub>DS</sub> = 250 V, V <sub>GS</sub> = 0 V		-	-	1	μA
DSS	Zero Gate Voltage Drain Current		١	$V_{DS} = 200 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$		-	-	10	
GSSF	Gate to Body Leakage Current, Forward		orward \	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V		-	-	10	μA
I <sub>GSSR</sub>	Gate to Body Leakage Current, Reverse		everse \	V <sub>GS</sub> = -20 V, V <sub>DS</sub> = 0 V		-	-	-10	μA
On Charac	torictics								
			, ,	( )( ) 050 A		4.0		0.5	
V <sub>GS(th)</sub>	Gate Threshold Voltage		$V_{GS} = V_{DS}, I_D = 250 \mu A$		1.0	-	2.5	V	
R <sub>DS(on)</sub>	Static Drain to Source On Resistance		nce L	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3.1 \text{ A}$		-	0.43	0.55	Ω
	Forward	Transconductance		$V_{GS} = 5 V, I_D = 3.1 A$ $V_{DS} = 20 V, I_D = 3.1 A$		-	0.45 7	0.57	S
9 <sub>FS</sub>	TUIWalu	Transconductance		$v_{\rm DS} = 20  v,  v_{\rm D} = 3.1  {\rm A}$		-	1	-	3
Dynamic C	haracte	ristics							
C <sub>iss</sub>	Input Cap	pacitance		$V_{DS} = 25 V, V_{GS} = 0 V,$		-	480	635	pF
C <sub>oss</sub>	Output C	apacitance				-	65	85	pF
C <sub>rss</sub>	Reverse	Transfer Capacitance		f = 1 MHz	_	-	8	12	pF
Q <sub>g(tot)</sub>	Total Gat	e Charge at 10V	1	V <sub>DS</sub> = 250 V I <sub>D</sub> = 6.2 A,		-	12	16	nC
Q <sub>gs</sub>	Gate to S	Source Gate Charge		$V_{GS} = 10 V$		-	1.5	-	nC
Q <sub>gd</sub>	Gate to D	Drain "Miller" Charge			(Note 4)	-	4	-	nC
Switching	Characte	eristics							
t <sub>d(on)</sub>		Delay Time				-	10	30	ns
t <sub>r</sub>		Rise Time	\ \	V <sub>DD</sub> = 250 V, I <sub>D</sub> = 6.2 A,		-	15	40	ns
t <sub>d(off)</sub>		Delay Time		$V_{\rm GS}$ = 10 V, R <sub>G</sub> = 25 $\Omega$	-		75	160	ns
t <sub>f</sub>	Turn-Off I	,			(Note 4)		30	70	ns
·		Characteristics	I			7	11		
	1	e Characteristics	Iroo Diodo I	Enward Current		-		6.2	A
I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current Maximum Pulsed Drain to Source Diode Forward Current				-	-	25	A	
I <sub>SM</sub>		Source Diode Forward Vo		$V_{GS} = 0 V, I_{SD} = 6.2 A$		-	-	1.4	V
V <sub>SD</sub>		Recovery Time	U				130		
t <sub>rr</sub> Q <sub>rr</sub>		Recovery Charge		V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 6.2 A, dI <sub>F</sub> /dt = 100 A/μs	-	-	0.6	-	ns
	i coreise i	Coovery charge	,	αιμαι - 100 Λιμο		-	0.0	-	μC



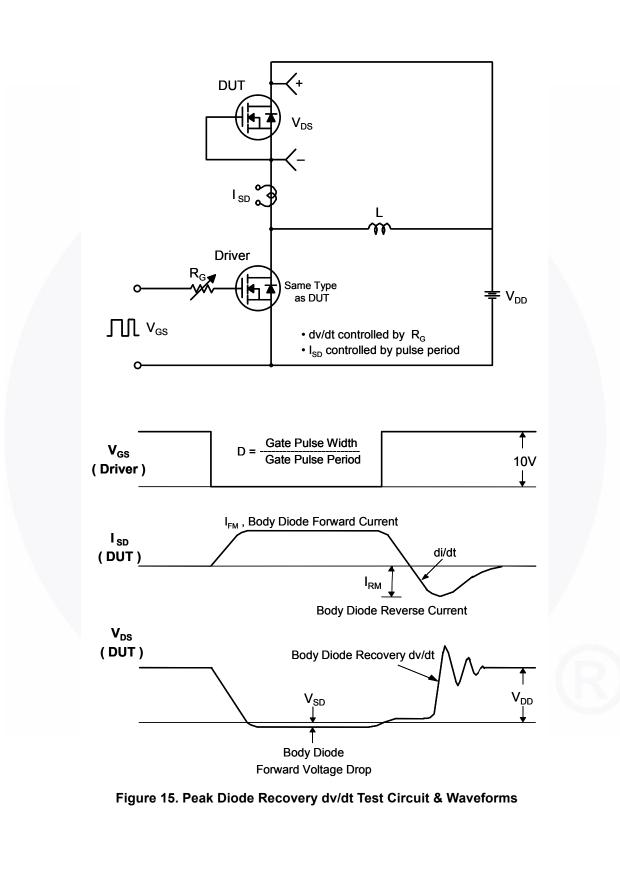
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